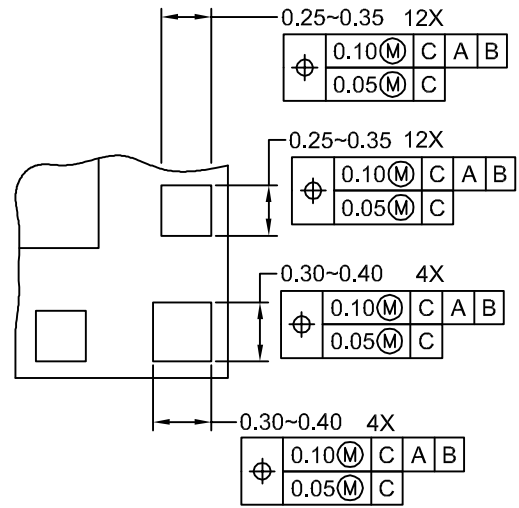
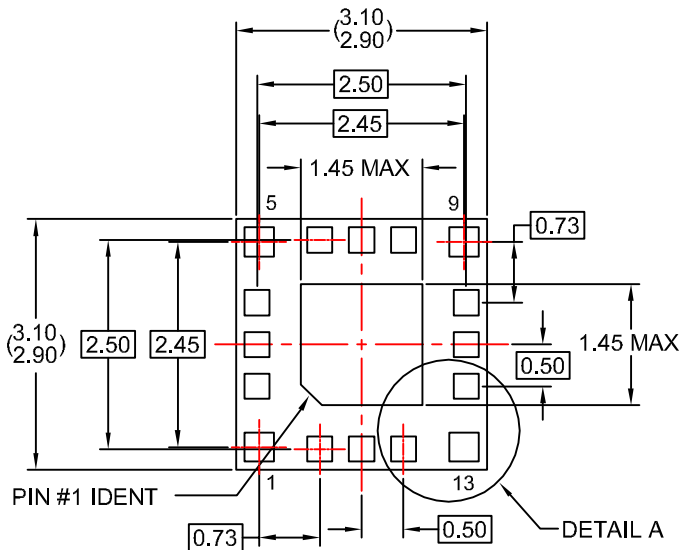
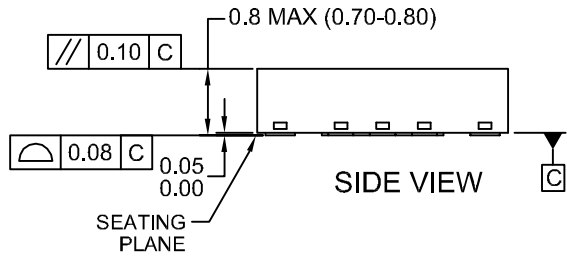
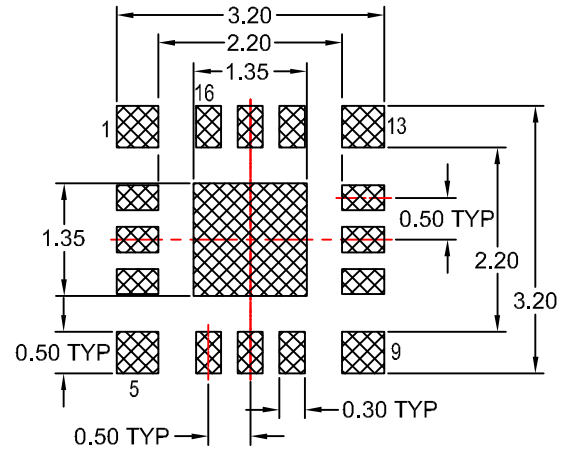
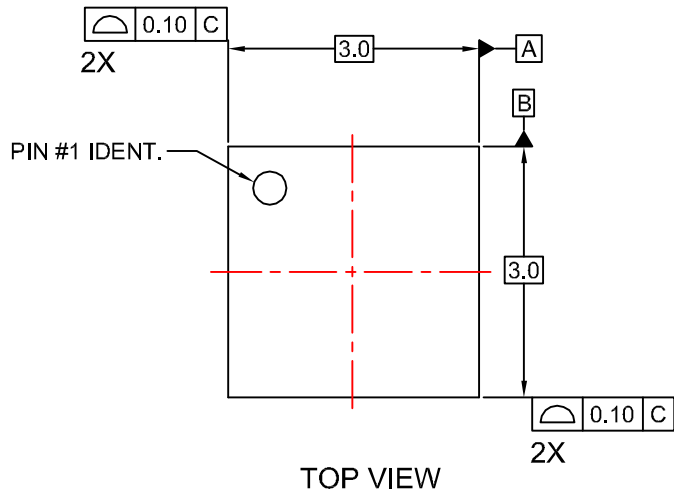


REVISIONS			
NBR	DESCRIPTION	DATE	DRAWN/SITE
A	RELEASE TO DOCUMENT CONTROL	14-11-2003	FEITAN
2	UPDATED DRAWING AND ADDED NON ASME TOLERANCE REFERENCE VALUES FOR BODY DIMS.	12-3-2008	L. England
3	Fixed min package thickness typo in side view.	4-29-2009	L. England
4	Removed extra squares on Bottom View.	7-6-2009	L. England



NOTES:

- A. SIMILAR TO JEDEC REGISTRATION MO-217,
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
- D. LANDPATTERN RECOMMENDATION IS PER FSC INTERNAL DESIGN
- E. DRAWING FILENAME: MLP16HBrev4

APPROVALS		DATE	FAIRCHILD SEMICONDUCTOR			
DRAWN	L. England	7-6-2009	16LD, MLP, JEDEC MO-217 EQUIVALENT, 3MM SQUARE			
DFTG. CHK.	S. Martin	7-6-2009				
ENGR. CHK.						
			SCALE	SIZE	DRAWING NUMBER	REV
			N/A	N/A	MKT-MLP16HB	4
			DO NOT SCALE DRAWING		SHEET 1 of 1	